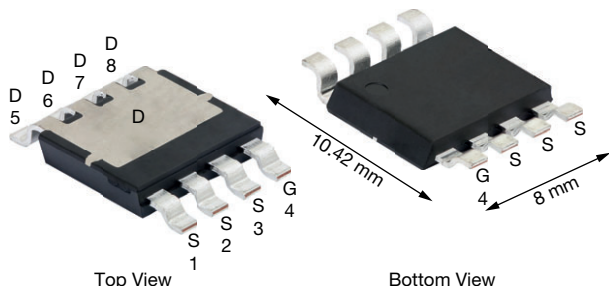
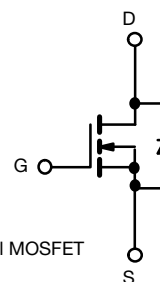


Automotive N-Channel 200 V (D-S) 175 °C MOSFET

PowerPAK® 8 x 8LR


FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Thin 1.9 mm height
- Material categorization:
for definitions of compliance please see
www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE


N-Channel MOSFET

PRODUCT SUMMARY

V_{DS} (V)	200
$R_{DS(on)}$ (Ω) at $V_{GS} = 10$ V	0.0143
I_D (A) ^e	95
Configuration	Single

ORDERING INFORMATION

Package	PowerPAK 8 x 8LR
Lead (Pb)-free and halogen-free	SQJQ190ER (for detailed order number please see www.vishay.com/doc?79776)

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	V_{DS}	200	V
Gate-source voltage	V_{GS}	± 20	
Continuous drain current ^e	I_D	$T_C = 25$ °C	A
		$T_C = 125$ °C	
Continuous source current (diode conduction) ^e	I_S	340	
Pulsed drain current ^{a, e}	I_{DM}	254	
Single pulse avalanche current	I_{AS}	44	
Single pulse avalanche energy	E_{AS}	96	mJ
Maximum power dissipation ^e	P_D	$T_C = 25$ °C	W
		$T_C = 125$ °C	
Operating junction and storage temperature range	T_J, T_{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) ^c		260	

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient	R_{thJA}	40	°C/W
Junction-to-lead (drain lead)	R_{thJL}	0.7	
Junction-to-case (heatsink tab) ^e	R_{thJC}	0.4	

Notes

- Pulse test; pulse width ≤ 300 μ s, duty cycle ≤ 2 %
- When mounted on 1" square PCB (FR4 material)
- See solder profile (www.vishay.com/doc?73257). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- As per on JESD51-14
- Values based on R_{thJC} and T_C of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system



SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA		200	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		2	3	3.5	
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V		-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 200 V	-	-	1	μA
		V _{GS} = 0 V	V _{DS} = 200 V, T _J = 125 °C	-	-	100	
		V _{GS} = 0 V	V _{DS} = 200 V, T _J = 175 °C	-	-	1000	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	V _{DS} ≥ 5 V	50	-	-	A
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A	-	0.0119	0.0143	Ω
		V _{GS} = 10 V	I _D = 20 A, T _J = 125 °C	-	-	0.0298	
		V _{GS} = 10 V	I _D = 20 A, T _J = 175 °C	-	-	0.0409	
Forward transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 30 A		-	65	-	S
Dynamic ^b							
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 100 V, f = 1 MHz	-	3187	4800	pF
Output capacitance	C _{oss}			-	347	550	
Reverse transfer capacitance	C _{rss}			-	13	26	
Total gate charge ^c	Q _g	V _{GS} = 10 V	V _{DS} = 100 V, I _D = 30 A	-	52	80	nC
Gate-source charge ^c	Q _{gs}			-	15	-	
Gate-drain charge ^c	Q _{gd}			-	14	-	
Gate resistance	R _g	f = 1 MHz		1.8	3.7	5.7	Ω
Turn-on delay time ^c	t _{d(on)}	V _{DD} = 100 V, R _L = 3.33 Ω, I _D ≅ 30 A, V _{GEN} = 10 V, R _g = 1 Ω		-	12	24	ns
Rise time ^c	t _r			-	6	12	
Turn-off delay time ^c	t _{d(off)}			-	37	74	
Fall time ^c	t _f			-	8	16	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed current ^a	I _{SM}			-	-	254	A
Forward voltage	V _{SD}	I _F = 40 A, V _{GS} = 0 V		-	0.81	1.1	V
Body diode reverse recovery time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs		-	117	234	ns
Body diode reverse recovery charge	Q _{rr}			-	631	1262	nC
Reverse recovery fall time	t _a			-	96	-	ns
Reverse recovery rise time	t _b			-	21	-	
Body diode peak reverse recovery current	I _{RM(REC)}			-	-10	-	A

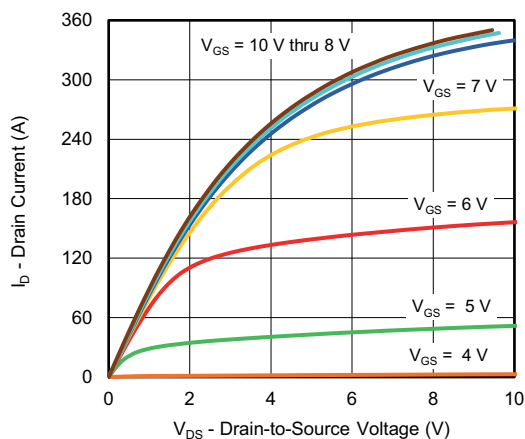
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

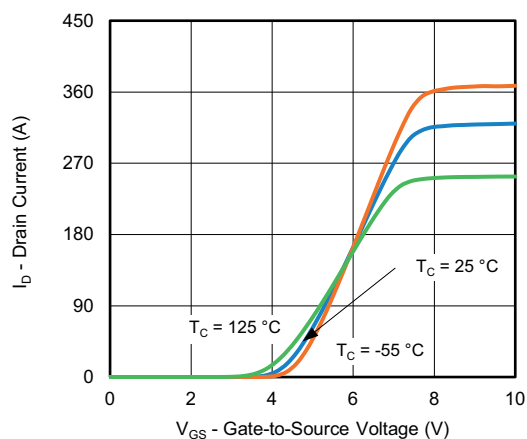
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



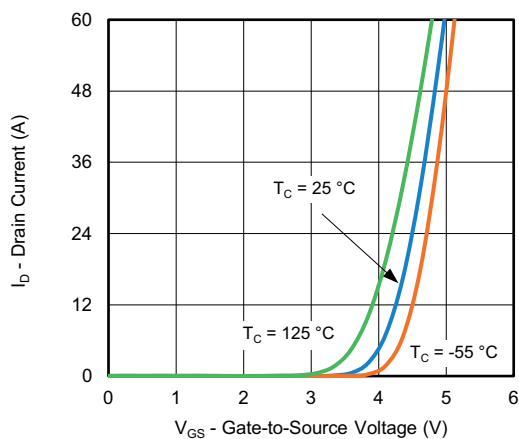
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



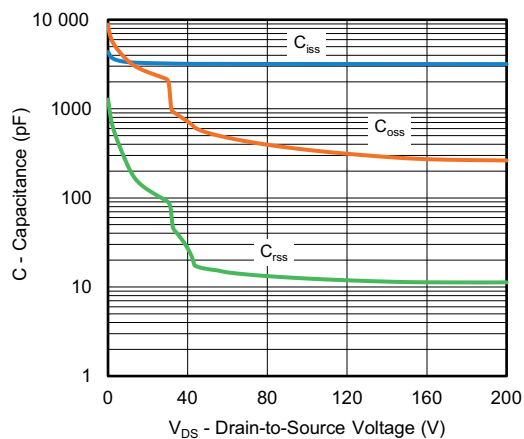
Output Characteristics



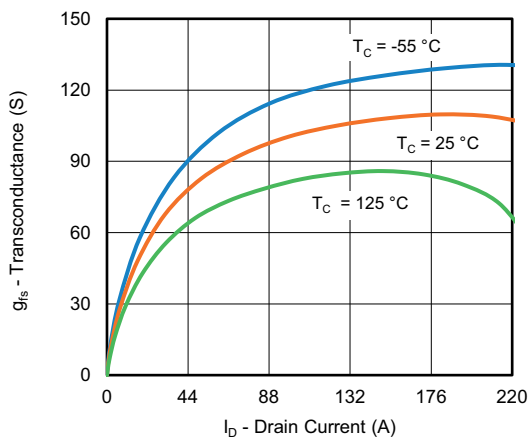
Transfer Characteristics



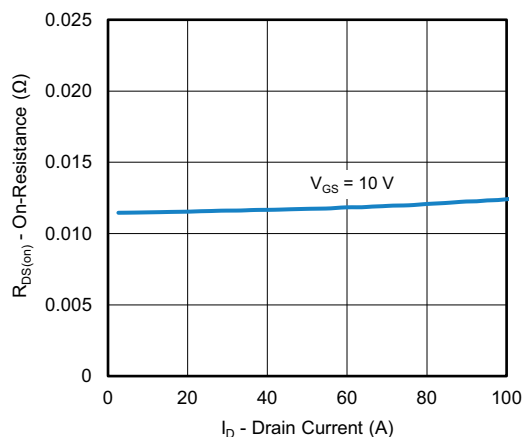
Transfer Characteristics



Capacitance



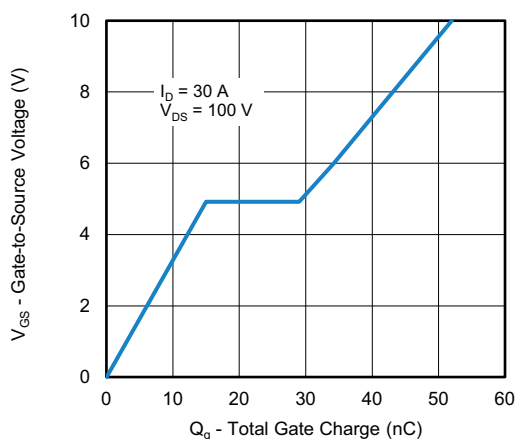
Transconductance



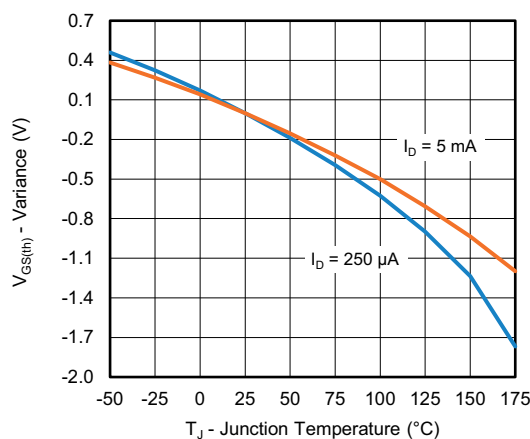
On-Resistance vs. Drain Current



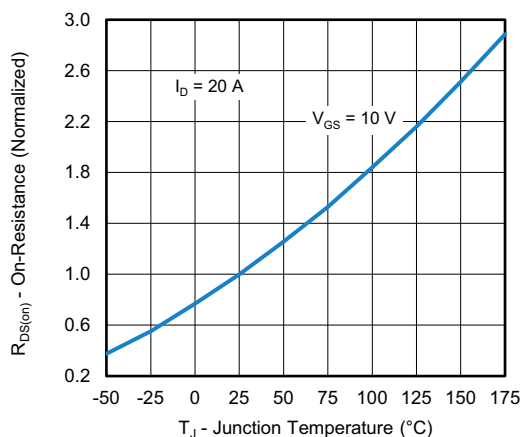
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



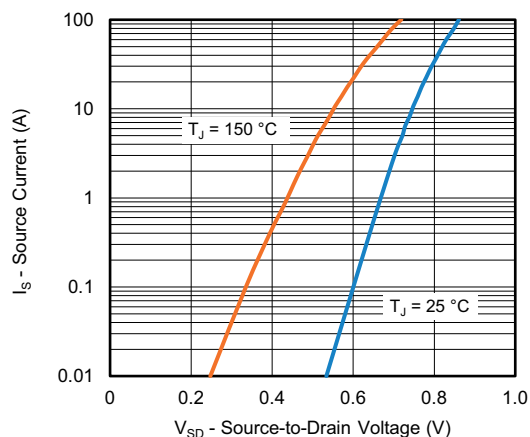
Gate Charge



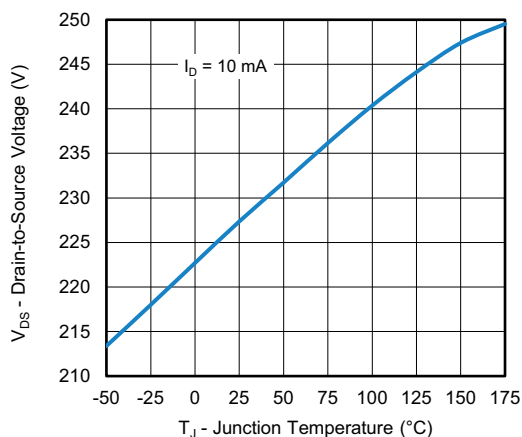
Threshold Voltage



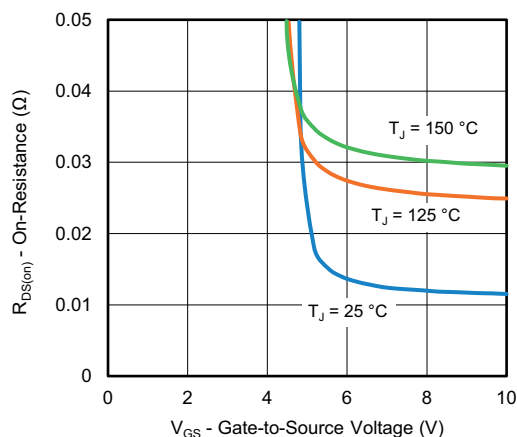
On-Resistance vs. Junction Temperature



Source Drain Diode Forward Voltage



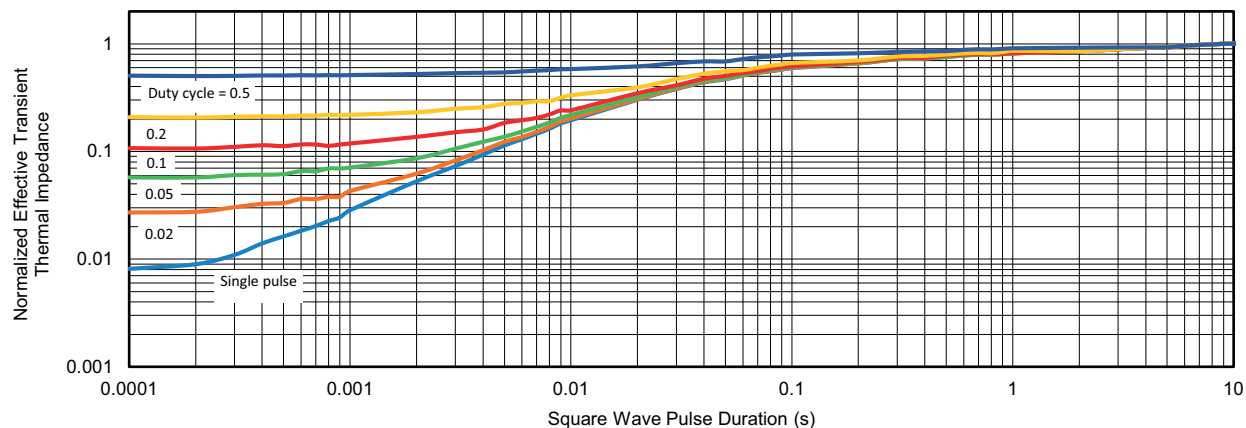
Drain Source Breakdown vs. Junction Temperature



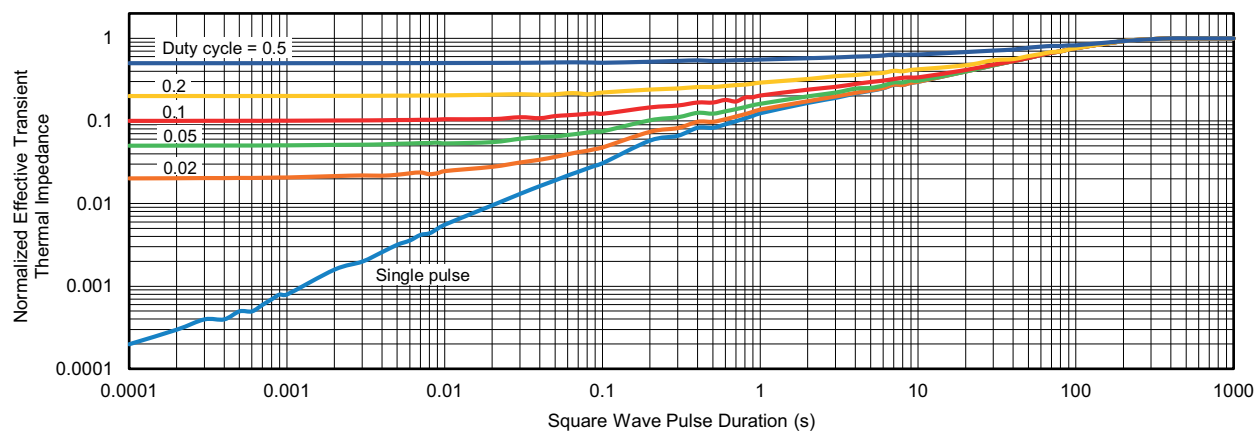
On-Resistance vs. Gate-to-Source Voltage



THERMAL RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

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